

## ASMD-LWG3-NxxxD

### 0.5W 3014 Surface Mount LED

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## Overview

The Broadcom<sup>®</sup> ASMD-LWG3-NxxxD Surface Mount LEDs use InGaN chip technology with superior package design to enable them to produce higher light output with better flux performance. The product can be driven at high current and are able to dissipate the heat more efficiently resulting in better performance with reliability.

These LEDs are able to be operated under a wide range of environmental conditions making it ideal for various applications, including fluorescent replacement, under cabinet lighting, retail display lighting and panel lights.

To facilitate easy pick-and-place assembly, the LEDs are packed in tape and reel form. Every reel is shipped in single flux and color bin, to provide close uniformity.

## Features

- High reliability package with enhanced silicone resin encapsulation.
- Available in 2700K, 3000K, 3500K, 4000K, 5000K, 5700K, 6200K, 6500K, and 6800K CCT.
- Low thermal resistance at 20°C/W.
- Super wide viewing angle at 120°.
- Low package profile and large emitting area for better uniformity in linear lighting.
- JEDEC MSL 3.

## Applications

- For lightings and luminaries.
- Electronic signs and signals.
  - Channel lettering
  - Contour lighting
  - Advertisement board backlighting
- Office automations, home appliances, industrial equipment.
  - Front panel backlighting
  - Pushbutton backlighting
  - Display backlighting
  - Scanner lighting

**CAUTION!** ASMD-LWG3-NxxxD LEDs are ESD sensitive. Please observe appropriate precautions during handling and processing. Refer to Broadcom Application Note AN-1142 for additional details.

Figure 1: Package Drawing



## NOTE:

1. All dimensions are in millimeters.
2. Dimensions in brackets are for reference only.
3. Tolerance is  $\pm 0.2$  mm unless otherwise specified.
4. Terminal finish = silver plating.

Device Selection Guide at 65 mA ( $T_J = 25^\circ\text{C}$ )

| Part Number     | Correlated Color Temperature, CCT (Kelvin) | Luminous Flux $\Phi_v$ (lm) <sup>a, b</sup> |      |      | Luminous Efficiency (lm/W) | Dice Technology |
|-----------------|--|---|------|------|----------------------------|-----------------|
|                 | Typ.                                       | Min.  | Typ. | Max. |                            |                 |
| ASMD-LWG3-NPSAD | 2700                                       | 20.0  | 22.4 | 28.0 | 115.3                      | InGaN           |
| ASMD-LWG3-NPSBD | 3000                                       | 20.0  | 23.0 | 28.0 | 118.3                      | InGaN           |
| ASMD-LWG3-NQTCD | 3500                                       | 22.0  | 23.5 | 30.0 | 120.9                      | InGaN           |
| ASMD-LWG3-NQTDD | 4000                                       | 22.0  | 24.5 | 30.0 | 126.1                      | InGaN           |
| ASMD-LWG3-NQTED | 5000                                       | 22.0  | 24.5 | 30.0 | 126.1                      | InGaN           |
| ASMD-LWG3-NQTFD | 5700                                       | 22.0  | 24.5 | 30.0 | 126.1                      | InGaN           |
| ASMD-LWG3-NQTGD | 6200                                       | 22.0  | 24.5 | 30.0 | 126.1                      | InGaN           |
| ASMD-LWG3-NQTHD | 6500                                       | 22.0  | 24.5 | 30.0 | 126.1                      | InGaN           |
| ASMD-LWG3-NQTJD | 6800                                       | 22.0  | 23.5 | 30.0 | 120.9                      | InGaN           |

a. Luminous flux,  $\Phi_v$  is the total flux output as measured with an integrating sphere at a single current pulse condition.

b. Flux tolerance is  $\pm 12\%$ .

## Absolute Maximum Ratings

| Parameters                        | ASMD-LWG3-NxxxD                         | Unit |
|-----------------------------------|---|------|
| DC Forward Current <sup>a</sup>   | 200                                     | mA   |
| Peak Forward Current <sup>b</sup> | 270                                     | mA   |
| Power Dissipation                 | 660                                     | mW   |
| Reverse Voltage                   | Not designed for reverse bias operation |      |
| Junction Temperature              | 110                                     | °C   |
| Operating Temperature             | -40 to +85                              | °C   |
| Storage Temperature               | -40 to +100                             | °C   |

a. Derate linearly as shown in Figure 15 and Figure 16.

b. Duty Factor = 10%, Frequency = 1 kHz.

## Optical and Electrical Characteristics at 65 mA ( $T_J = 25^\circ\text{C}$ )

| Parameters                                  | Min. | Typ. | Max. | Unit |
|---|------|------|------|------|
| Viewing Angle, $2\theta_{1/2}$ <sup>a</sup> | —    | 120  | —    | °    |
| Forward Voltage, $V_F$ <sup>b</sup>         | 2.80 | 2.99 | 3.30 | V    |
| Color Rendering Index, CRI                  | 80   | —    | —    | —    |
| Thermal Resistance, $R_{\theta J-S}$        | —    | 20   | —    | °C/W |

a.  $\theta_{1/2}$  is the off-axis angle where the luminous intensity is half of the peak intensity.

b. Forward voltage tolerance is  $\pm 0.1\text{V}$ .

## Performance Characteristics ( $T_J = 25^\circ\text{C}$ )

| Forward Current (mA) | Relative Luminous Flux<br>(normalized at 65 mA) | Luminous Flux, $\Phi_V$ (lm) | Forward Voltage, $V_F$ (V) | Luminous Efficiency<br>(lm/W) |
|----------------------|---|------------------------------|----------------------------|-------------------------------|
|                      |   | Typ.                         | Typ.                       | Typ.                          |
| <b>2700K</b>         |   |                              |                            |                               |
| 10                   | 0.166   | 3.7                          | 2.78                       | 133.8                         |
| 20                   | 0.327   | 7.3                          | 2.82                       | 130.0                         |
| 30                   | 0.485   | 10.9                         | 2.86                       | 126.5                         |
| 40                   | 0.638   | 14.3                         | 2.90                       | 123.2                         |
| 50                   | 0.788   | 17.6                         | 2.94                       | 120.1                         |
| 60                   | 0.934   | 20.9                         | 2.97                       | 117.3                         |
| 65                   | 1.000   | 22.4                         | 2.99                       | 115.3                         |
| 80                   | 1.215   | 27.2                         | 3.04                       | 112.0                         |
| 100                  | 1.482   | 33.2                         | 3.10                       | 107.2                         |
| 120                  | 1.736   | 38.9                         | 3.15                       | 102.8                         |
| 150                  | 2.094   | 46.9                         | 3.23                       | 96.9                          |
| 200                  | 2.633   | 59.0                         | 3.35                       | 88.2                          |

| Forward Current (mA)                         | Relative Luminous Flux<br>(normalized at 65 mA) | Luminous Flux, $\Phi_V$ (lm) | Forward Voltage, $V_F$ (V) | Luminous Efficiency<br>(lm/W) |
|--|---|------------------------------|----------------------------|-------------------------------|
|  |   | Typ.                         | Typ.                       | Typ.                          |
| <b>3000K</b>                                 |   |                              |                            |                               |
| 10   | 0.166   | 3.8                          | 2.78                       | 137.4                         |
| 20   | 0.327   | 7.5                          | 2.82                       | 133.4                         |
| 30   | 0.485   | 11.1                         | 2.86                       | 129.8                         |
| 40   | 0.638   | 14.7                         | 2.90                       | 126.5                         |
| 50   | 0.788   | 18.1                         | 2.94                       | 123.4                         |
| 60   | 0.934   | 21.5                         | 2.97                       | 120.4                         |
| 65   | 1.000   | 23.0                         | 2.99                       | 118.4                         |
| 80   | 1.215   | 27.9                         | 3.04                       | 115.0                         |
| 100  | 1.482   | 34.1                         | 3.10                       | 110.0                         |
| 120  | 1.736   | 39.9                         | 3.15                       | 105.5                         |
| 150  | 2.094   | 48.2                         | 3.23                       | 99.4                          |
| 200  | 2.633   | 60.6                         | 3.35                       | 90.5                          |
| <b>3500K</b>                                 |   |                              |                            |                               |
| 10   | 0.166   | 3.9                          | 2.78                       | 140.4                         |
| 20   | 0.327   | 7.7                          | 2.82                       | 136.3                         |
| 30   | 0.485   | 11.4                         | 2.86                       | 132.7                         |
| 40   | 0.638   | 15.0                         | 2.90                       | 129.2                         |
| 50   | 0.788   | 18.5                         | 2.94                       | 126.0                         |
| 60   | 0.934   | 21.9                         | 2.97                       | 123.0                         |
| 65   | 1.000   | 23.5                         | 2.99                       | 120.9                         |
| 80   | 1.215   | 28.5                         | 3.04                       | 117.5                         |
| 100  | 1.482   | 34.8                         | 3.10                       | 112.4                         |
| 120  | 1.736   | 40.8                         | 3.15                       | 107.8                         |
| 150  | 2.094   | 49.2                         | 3.23                       | 101.6                         |
| 200  | 2.633   | 61.9                         | 3.35                       | 92.5                          |
| 50   | 0.788   | 18.5                         | 2.94                       | 126.0                         |
| <b>4000K, 5000K, 5700K, 6200K, and 6500K</b> |   |                              |                            |                               |
| 10   | 0.166   | 4.1                          | 2.78                       | 146.4                         |
| 20   | 0.327   | 8.0                          | 2.82                       | 142.1                         |
| 30   | 0.485   | 11.9                         | 2.86                       | 138.3                         |
| 40   | 0.638   | 15.6                         | 2.90                       | 134.7                         |
| 50   | 0.788   | 19.3                         | 2.94                       | 131.4                         |
| 60   | 0.934   | 22.9                         | 2.97                       | 128.3                         |
| 65   | 1.000   | 24.5                         | 2.99                       | 126.1                         |
| 80   | 1.215   | 29.8                         | 3.04                       | 122.5                         |
| 100  | 1.482   | 36.3                         | 3.10                       | 117.2                         |
| 120  | 1.736   | 42.5                         | 3.15                       | 112.4                         |
| 150  | 2.094   | 51.3                         | 3.23                       | 105.9                         |
| 200  | 2.633   | 64.5                         | 3.35                       | 96.4                          |

| Forward Current (mA) | Relative Luminous Flux<br>(normalized at 65 mA) | Luminous Flux, $\Phi_V$ (lm) | Forward Voltage, $V_F$ (V) | Luminous Efficiency<br>(lm/W) |
|----------------------|---|------------------------------|----------------------------|-------------------------------|
|                      |   | Typ.                         | Typ.                       | Typ.                          |
| <b>6800K</b>         |   |                              |                            |                               |
| 10                   | 0.166   | 3.9                          | 2.78                       | 140.4                         |
| 20                   | 0.327   | 7.7                          | 2.82                       | 136.3                         |
| 30                   | 0.485   | 11.4                         | 2.86                       | 132.7                         |
| 40                   | 0.638   | 15.0                         | 2.90                       | 129.2                         |
| 50                   | 0.788   | 18.5                         | 2.94                       | 126.0                         |
| 60                   | 0.934   | 21.9                         | 2.97                       | 123.0                         |
| 65                   | 1.000   | 23.5                         | 2.99                       | 120.9                         |
| 80                   | 1.215   | 28.5                         | 3.04                       | 117.5                         |
| 100                  | 1.482   | 34.8                         | 3.10                       | 112.4                         |
| 120                  | 1.736   | 40.8                         | 3.15                       | 107.8                         |
| 150                  | 2.094   | 49.2                         | 3.23                       | 101.6                         |
| 200                  | 2.633   | 61.9                         | 3.35                       | 92.5                          |

## Part Numbering System

A S M D - L W x<sub>1</sub> 3 - N x<sub>2</sub> x<sub>3</sub> x<sub>4</sub> x<sub>5</sub>

| Code           | Description           | Option                               |
|----------------|-----------------------|--------------------------------------|
| x <sub>1</sub> | Color Rendering Index | G – CRI ≥80                          |
| x <sub>2</sub> | Minimum Flux Bin      | Refer to Flux Bin Limits (CAT) table |
| x <sub>3</sub> | Maximum Flux Bin      |                                      |
| x <sub>4</sub> | Color Bin             | A – 2700K                            |
|                |                       | B – 3000K                            |
|                |                       | C – 3500K                            |
|                |                       | D – 4000K                            |
|                |                       | E – 5000K                            |
|                |                       | F – 5700K                            |
|                |                       | G – 6200K                            |
|                |                       | H – 6500K                            |
|                | J – 6800K             |                                      |
| x <sub>5</sub> | Test Option           | D – Test Current = 65 mA             |

## Part Number Example

ASMD-LWG3-NPSBD

x<sub>1</sub>: G – CRI ≥80

x<sub>2</sub>: P – Minimum flux bin P

x<sub>3</sub>: S – Maximum flux bin S

x<sub>4</sub>: B – Color bin CCT 3000K with bin ID 29S

x<sub>5</sub>: D – Test current = 65mA

## Bin Information

### Flux Bin Limits (CAT)

| Bin ID | Luminous Flux, $\Phi_v$ (lm) at 65 mA |      |
|--------|---------------------------------------|------|
|        | Min.                                  | Max. |
| P      | 20                                    | 22   |
| Q      | 22                                    | 24   |
| R      | 24                                    | 26   |
| S      | 26                                    | 28   |
| T      | 28                                    | 30   |

Tolerance:  $\pm 12\%$ .

### Forward Voltage Bin Limits (VF)

| Bin ID | Forward Voltage, $V_F$ (V) at 65 mA |      |
|--------|-------------------------------------|------|
|        | Min.                                | Max. |
| G03    | 2.8                                 | 2.9  |
| G04    | 2.9                                 | 3.0  |
| G05    | 3.0                                 | 3.1  |
| G06    | 3.1                                 | 3.2  |
| G07    | 3.2                                 | 3.3  |

Tolerance:  $\pm 0.1$  V.

Example of bin information on reel and packaging label:

CAT: P – Flux bin P

VIN: 29S – Color bin 29S

VF: G05 – VF bin G05

### Color Bin Limits (BIN)

| CCT  | Bin ID | Chromaticity Coordinates |        |
|------|--------|--------------------------|--------|
|      |        | x                        | y      |
| 2700 | 27S    | 0.4475                   | 0.4012 |
|      |        | 0.4582                   | 0.4199 |
|      |        | 0.4708                   | 0.4228 |
|      |        | 0.4598                   | 0.4041 |
| 3000 | 29S    | 0.4295                   | 0.3918 |
|      |        | 0.4381                   | 0.4097 |
|      |        | 0.4515                   | 0.4145 |
|      |        | 0.4420                   | 0.3962 |
| 3500 | 34S    | 0.4006                   | 0.3811 |
|      |        | 0.4061                   | 0.3980 |
|      |        | 0.4226                   | 0.4056 |
|      |        | 0.4150                   | 0.3881 |
| 4000 | 41S    | 0.3699                   | 0.3646 |
|      |        | 0.3743                   | 0.3846 |
|      |        | 0.3885                   | 0.3934 |
|      |        | 0.3835                   | 0.3741 |
| 5000 | 50S    | 0.3372                   | 0.3449 |
|      |        | 0.3378                   | 0.3596 |
|      |        | 0.3496                   | 0.3694 |
|      |        | 0.3478                   | 0.3533 |
| 5700 | 58G    | 0.3220                   | 0.3280 |
|      |        | 0.3209                   | 0.3425 |
|      |        | 0.3330                   | 0.3533 |
|      |        | 0.3329                   | 0.3375 |
| 6200 | 62G    | 0.3133                   | 0.3214 |
|      |        | 0.3113                   | 0.3350 |
|      |        | 0.3208                   | 0.3444 |
|      |        | 0.3219                   | 0.3296 |
| 6500 | 64S    | 0.3079                   | 0.3274 |
|      |        | 0.3068                   | 0.3354 |
|      |        | 0.3181                   | 0.3467 |
|      |        | 0.3192                   | 0.3387 |
| 6800 | 68G    | 0.3061                   | 0.3145 |
|      |        | 0.3035                   | 0.3272 |
|      |        | 0.3113                   | 0.3350 |
|      |        | 0.3133                   | 0.3214 |

Tolerance:  $\pm 0.01$ .

Figure 2: Chromaticity Diagram





Figure 3: Spectral Power Distribution



Figure 4: Forward Current vs. Forward Voltage

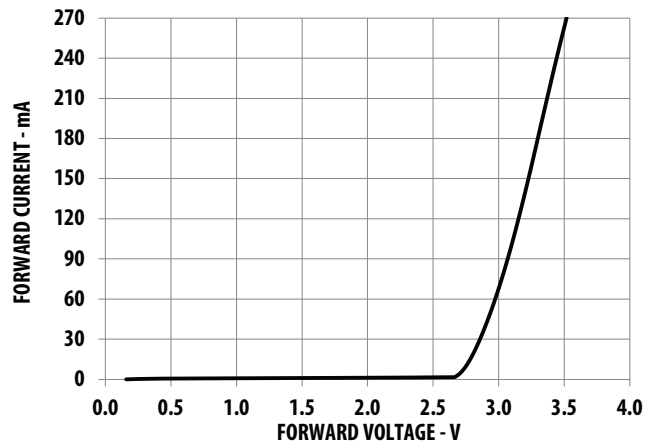


Figure 5: Relative Luminous Flux vs. Mono Pulse Current



Figure 6: Radiation Pattern



Figure 7: Chromaticity Coordinate Shift vs. Mono Pulse Current for 3000K

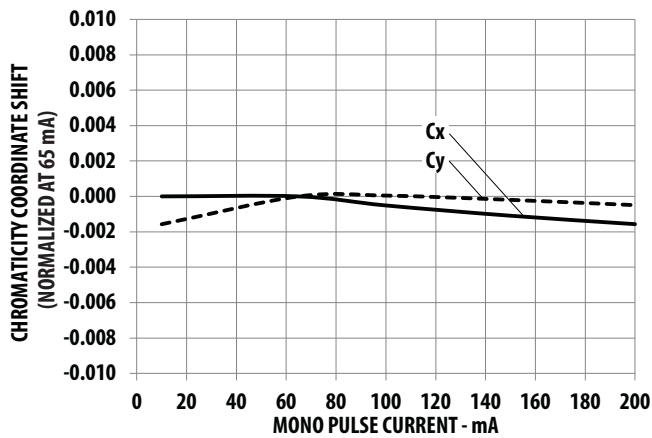


Figure 8: Chromaticity Coordinate Shift vs. Mono Pulse Current for 4000K

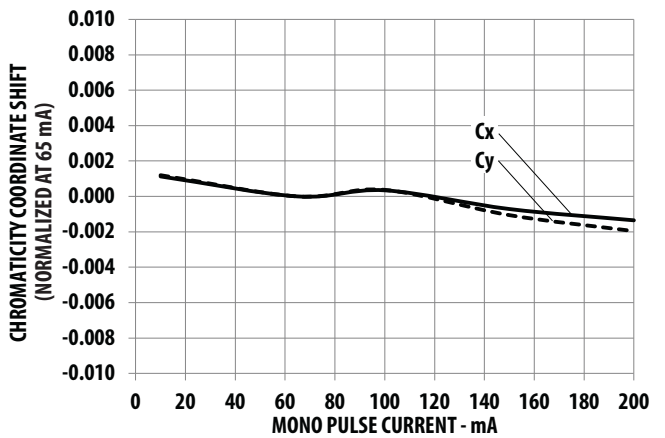


Figure 9: Chromaticity Coordinate Shift vs. Mono Pulse Current for 6500K



Figure 10: Relative Light Output vs. Junction Temperature



Figure 11: Forward Voltage Shift vs. Junction Temperature

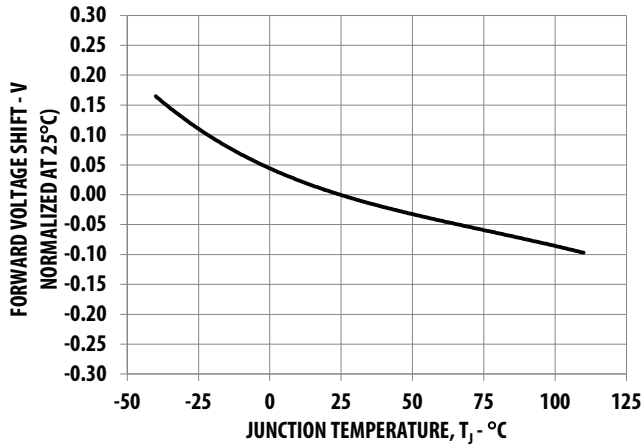


Figure 12: Chromaticity Coordinate Shift vs. Junction Temperature for 3000K



Figure 13: Chromaticity Coordinate Shift vs. Junction Temperature for 4000K



Figure 14: Chromaticity Coordinate Shift vs. Junction Temperature for 6500K



Figure 15: Maximum Forward Current vs. Ambient Temperature. Derated based on  $T_{JMAX} = 110^{\circ}C$ ,  $R_{\theta J-A} = 120^{\circ}C/W$ ,  $140^{\circ}C/W$  and  $160^{\circ}C/W$ .



Figure 16: Maximum Forward Current vs. Solder Point Temperature. Derated based on  $T_{JMAX} = 110^{\circ}C$ ,  $R_{\theta J-S} = 20^{\circ}C/W$ .

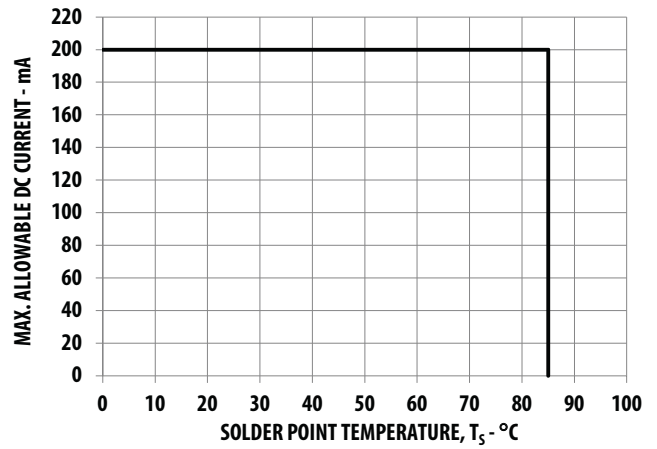
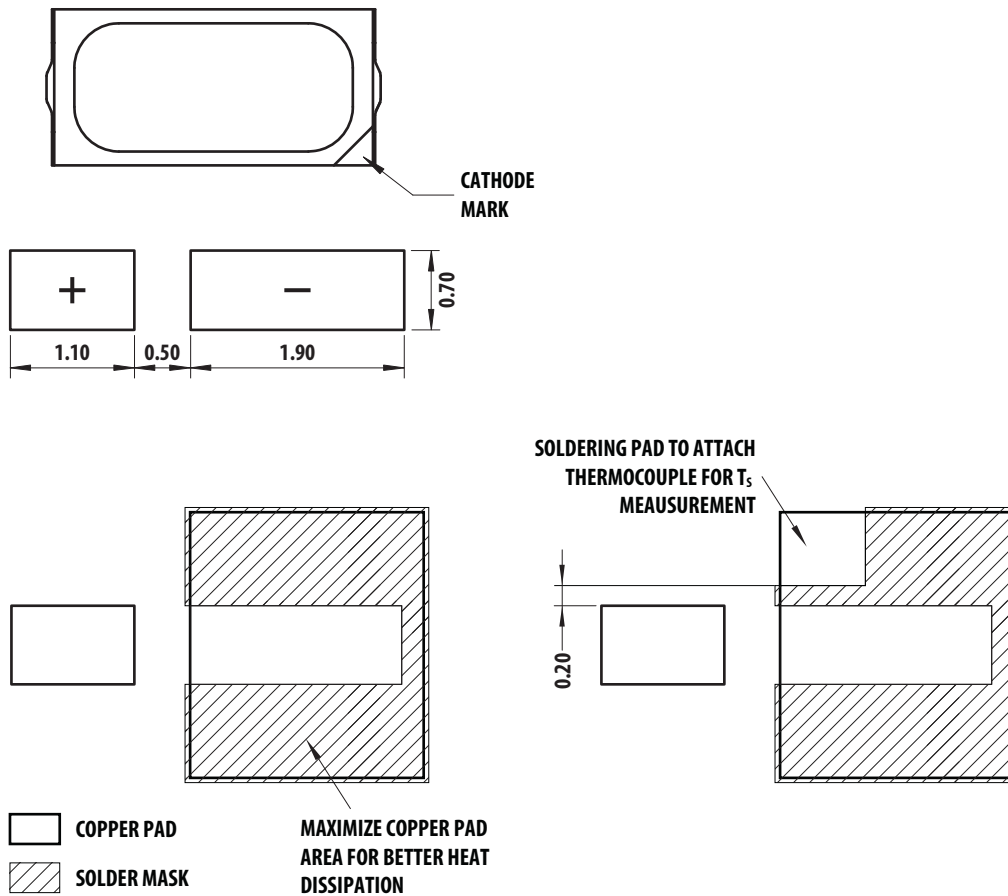


Figure 17: Recommended Soldering Pad Pattern



**Figure 18: Carrier Tape Dimensions**



**NOTE:** All dimensions are in millimeters.

**Figure 19: Reel Dimensions**



**NOTE:** All dimensions are in millimeters.

## Precautionary Notes

### Soldering

- Do not perform reflow soldering more than twice. Observe necessary precautions of handling moisture-sensitive devices, as stated in the following section.
- Do not apply any pressure or force on the LED during reflow and after reflow when the LED is still hot.
- Use reflow soldering to solder the LED. Use hand soldering only for rework if unavoidable, but it must be strictly controlled to the following conditions:
  - Solder iron tip temperature = 315°C max.
  - Solder duration = 3 seconds max.
  - Number of cycles = 1 only
  - Power of soldering iron = 50W max.
- Do not touch the LED package body with the soldering iron except for the soldering terminals, as it may cause damage to the LED.
- Confirm beforehand whether the functionality and performance of the LED is affected by soldering with hand soldering.

Figure 20: Recommended Lead-Free Reflow Soldering Condition



### Handling Precautions

The encapsulation material of the LED is made of silicone for better product reliability. Compared to epoxy encapsulant, which is hard and brittle, silicone is softer and flexible. Observe special handling precautions during assembly of silicone encapsulated LED products. Failure to comply may lead to damage and premature failure of the LED. Refer to Broadcom Application Note AN5288, *Silicone Encapsulation for LED: Advantages and Handling Precautions*, for additional information.

- Do not poke sharp objects into the silicone encapsulant. Sharp objects, such as tweezers or syringes, might apply excessive force or even pierce through the silicone and induce failures to the LED die or wire bond.
- Do not touch the silicone encapsulant. Uncontrolled force acting on the silicone encapsulant might result in excessive stress on the wire bond. Hold the LED only by the body.
- Do not stack assembled PCBs together. Use an appropriate rack to hold the PCBs.
- The surface of silicone material attracts dust and dirt easier than epoxy due to its surface tackiness. To remove foreign particles on the surface of silicone, use a cotton bud with isopropyl alcohol (IPA). During cleaning, rub the surface gently without putting too much pressure on the silicone. Ultrasonic cleaning is not recommended.
- For automated pick and place, Broadcom has tested a nozzle size with OD 1.5 mm to work with this LED. However, due to the possibility of variations in other parameters, such as pick and place machine maker/model, and other settings of the machine, verify that the selected nozzle will not cause damage to the LED.

### Handling of Moisture Sensitive Devices

This product has a Moisture Sensitive Level 3 rating per JEDEC J-STD-020. Refer to Broadcom Application Note AN5305, *Handling of Moisture Sensitive Surface Mount Devices* for additional details and a review of proper handling procedures.

- Before use:
  - An unopened moisture barrier bag (MBB) can be stored at < 40°C/90% RH for 12 months. If the actual shelf life has exceeded 12 months and the Humidity Indicator Card (HIC) indicates that baking is not required, then it is safe to reflow the LEDs per the original MSL rating.
  - Do not open the MBB prior to assembly (for example, for IQC). If unavoidable, the MBB must be properly resealed with fresh desiccant and HIC. The exposed duration must be taken in as floor life.
- Control after opening the MBB:
  - Read the HIC immediately upon opening of the MBB.
  - Keep the LEDs at < 30°C/60% RH at all times, and complete all high temperature-related processes, including soldering, curing, or rework, within 168 hours.

- Control for the unfinished reel:  
Store unused LEDs in a sealed MBB with desiccant or a desiccator at < 5% RH.
- Control of assembled boards:  
If the PCB soldered with the LEDs is to be subjected to other high-temperature processes, store the PCB in a sealed MBB with desiccant or desiccator at < 5% RH to ensure that all LEDs have not exceeded their floor life of 168 hours.
- Baking is required if the following conditions apply.
  - The HIC indicator is not BLUE at 10% and is PINK at 5%.
  - The LEDs are exposed to conditions of > 30°C/60% RH at any time.
  - The LEDs' floor life exceeded 168 hours.
 The recommended baking condition is 60°C ±5°C for 20 hours.  
Baking should only be done once.
- Storage:  
The soldering terminals of these Broadcom LEDs are silver plated. If the LEDs are exposed in ambient environment for too long, the silver plating might be oxidized, thus affecting its solderability performance. As such, keep unused LEDs in a sealed MBB with dessicant or in dessicator at < 5% RH.

## Application Precautions

- The drive current of the LED must not exceed the maximum allowable limit across temperature as stated in the data sheet. Constant current driving is recommended to ensure consistent performance.
- Circuit design must cater to the whole range of the forward voltage ( $V_F$ ) of the LEDs to ensure the intended drive current can always be achieved.
- The LED exhibits slightly different characteristics at different drive currents, which may result in a larger variation of performance (meaning: intensity, wavelength, and forward voltage). Set the application current as close as possible to the test current to minimize these variations.
- The LED is not intended for reverse bias. Use other appropriate components for such purposes. When driving the LED in matrix form, ensure that the reverse bias voltage does not exceed the allowable limit of the LED.
- Do not use the LED in the vicinity of materials with sulfur content or in environments of high gaseous sulfur compounds and corrosive elements. Examples of

materials that might contain sulfur are rubber gaskets, room-temperature vulcanizing (RTV) silicone rubber, rubber gloves, and so on. Prolonged exposure to such environments may affect the optical characteristics and product life.

- White LEDs must not be exposed to acidic environments and must not be used in the vicinity of any compound that may have acidic outgas, such as, but not limited to, acrylate adhesive. These environments have an adverse effect on LED performance.
- Avoid rapid change in ambient temperatures, especially in high-humidity environments, because they cause condensation on the LED.
- If the LED is intended to be used in a harsh or outdoor environment, protect the LED against damages caused by rain water, water, dust, oil, corrosive gases, external mechanical stress, and so on.

## Thermal Management

Optical, electrical, and reliability characteristics of the LED are affected by temperature. Keep the junction temperature ( $T_J$ ) of the LED below the allowable limit at all times.  $T_J$  can be calculated as follows:

$$T_J = T_A + R_{\theta J-A} \times I_F \times V_{Fmax}$$

where;  $T_A$  = ambient temperature (°C)

$R_{\theta J-A}$  = thermal resistance from LED junction to ambient (°C/W)

$I_F$  = forward current (A)

$V_{Fmax}$  = maximum forward voltage (V)

The complication of using this formula lies in  $T_A$  and  $R_{\theta J-A}$ . Actual  $T_A$  is sometimes subjective and hard to determine.  $R_{\theta J-A}$  varies from system to system depending on design and is usually not known.

Another way of calculating  $T_J$  is by using the solder point temperature,  $T_S$  as follows:

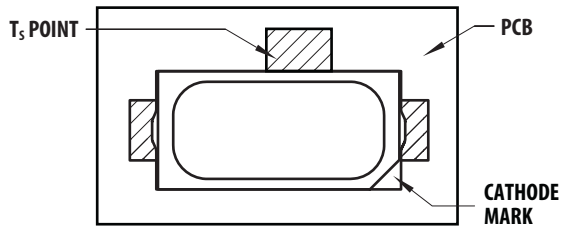
$$T_J = T_S + R_{\theta J-S} \times I_F \times V_{Fmax}$$

where;  $T_S$  = LED solder point temperature as shown in the following figure (°C)

$R_{\theta J-S}$  = thermal resistance from junction to solder point (°C/W)

$I_F$  = forward current (A)

$V_{Fmax}$  = maximum forward voltage (V)

**Figure 21: Solder Point Temperature on the PCB**

$T_S$  can be easily measured by mounting a thermocouple on the soldering joint as shown in the preceding figure, while  $R_{\theta J-S}$  is provided in the data sheet. Verify the  $T_S$  of the LED in the final product to ensure that the LEDs are operating within all maximum ratings stated in the data sheet.

## Eye Safety Precautions

LEDs may pose optical hazards when in operation. Do not look directly at operating LEDs because it might be harmful to the eyes. For safety reasons, use appropriate shielding or personal protective equipment.

## Disclaimer

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Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкуренспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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